SiJA54DP

RoHS COMPLIANT

HALOGEN

FREE

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**Vishay Siliconix** 

## N-Channel 40 V (D-S) MOSFET

PRODU	CT SUMMARY		
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω) Max.	I <sub>D</sub> (A) <sup>a, g</sup>	Q <sub>g</sub> (Typ.)
40	0.00235 at V <sub>GS</sub> = 10 V	60	32 nC
40	0.00320 at V <sub>GS</sub> = 4.5 V	60	

# PowerPAK<sup>®</sup> SO-8L Single G Top View Bottom View

**Ordering Information:** 

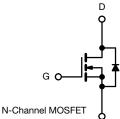
SiJA54DP-T1-GE3 (lead (Pb)-free and halogen-free)

#### **FEATURES**

- TrenchFET<sup>®</sup> Gen IV power MOSFET
- Tuned for the lowest R<sub>DS</sub>-Q<sub>oss</sub> FOM
- 100 % R<sub>q</sub> and UIS tested
- Q<sub>ad</sub> / Q<sub>as</sub> ratio < 1 optimizes switching</li> characteristics
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- Synchronous rectification
- ORing
- High power density DC/DC
- VRMs and embedded DC/DC
- DC/AC inverters
- · Load switch



ABSOLUTE MAXIMUM RATINGS (	T <sub>A</sub> = 25 °C, unless	otherwise noted	(k	
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V <sub>DS</sub>	40	V
Gate-Source Voltage		V <sub>GS</sub>	+20, -16	V
	T <sub>C</sub> = 25 °C		60 <sup>g</sup>	
Continuous Duoin Current (T. 150 °C)	T <sub>C</sub> = 70 °C		<b>60</b> g	
Continuous Drain Current ( $T_J = 150 \ ^{\circ}C$ )	T <sub>A</sub> = 25 °C	I <sub>D</sub>	32.2 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C		25.7 <sup>b, c</sup>	Α
Pulsed Drain Current (t = 100 µs)	·	I <sub>DM</sub>	150	A
Continuous Source Drain Diada Current	T <sub>C</sub> = 25 °C		33.3	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	4 <sup>b, c</sup>	
Single Pulse Avalanche Current		I <sub>AS</sub>	30	
Single Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	45	mJ
	T <sub>C</sub> = 25 °C		36.7	
Maximum Davies Diacia atian	T <sub>C</sub> = 70 °C	P	23.5	w
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	4.4 <sup>b, c</sup>	vv
	T <sub>A</sub> = 70 °C		2.8 <sup>b, c</sup>	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Soldering Recommendations (Peak Temperature) d, e			260	-0

THERMAL RESISTANCE RATINGS	5				
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 10 s	R <sub>thJA</sub>	24	28	°C/W
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	2.5	3.4	0/10

#### Notes

- a. T<sub>C</sub> = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

- d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under steady state conditions is 70 °C/W.

g. Package limited.

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For technical questions, contact: pmostechsupport@vishay.com

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## SiJA54DP

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static				•		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_{D} = 250 \mu A$	40	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$	L 050 A	-	24	-	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-5.2	-	mV/°(
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.1	-	2.4	V
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = +20 V, -16 V	-	-	± 100	nA
7		$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	-	-	10	μA
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30	-	-	А
	_ ` `	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A	-	0.00195	0.00235	-
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 10 A			0.00320	Ω
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 15 A	-	106	-	S
Dynamic <sup>b</sup>					1 1	
Input Capacitance	Ciss		-	5300	-	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	707	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	105	-	
	Qg	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	-	69	104	nC
Total Gate Charge			-	32	48	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$	-	13.5	-	
Gate-Drain Charge	Q <sub>ad</sub>		-	6.9	-	
Output Charge	Q <sub>oss</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$	-	30.5	46	
Gate Resistance	Rg	f = 1 MHz	0.4	1.1	2.0	Ω
Turn-On Delay Time	t <sub>d(on)</sub>		-	8	16	
Rise Time	t <sub>r</sub>	$V_{DD} = 20 V, R_1 = 2 \Omega$	-	8	16	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	28	56	
Fall Time	t <sub>f</sub>		-	7	14	
Turn-On Delay Time	t <sub>d(on)</sub>		-	24	48	ns
Rise Time	t <sub>r</sub>	$V_{DD} = 20 V, R_1 = 2 \Omega$	-	69	138	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{\text{GEN}} = 4.5 \text{ V}, R_g = 1 \Omega$	-	23	46	
Fall Time	t <sub>f</sub>		-	10	20	
Drain-Source Body Diode Characteristic	S			-	1 1	
Continuous Source-Drain Diode Current	ا <sub>s</sub>	T <sub>C</sub> = 25 °C	-	-	33.3	
Pulse Diode Forward Current (t = 100 µs)	I <sub>SM</sub>	-	-	- 1	150	A
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 5 A	-	0.72	1.1	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	-	-	44	88	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>		-	58	116	nC
Reverse Recovery Fall Time	ta	I <sub>F</sub> = 10 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C	-	29	-	
Reverse Recovery Rise Time	t <sub>b</sub>		-	15		ns

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

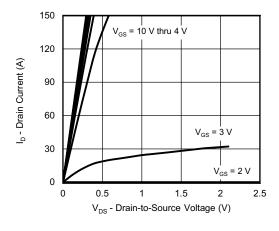
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

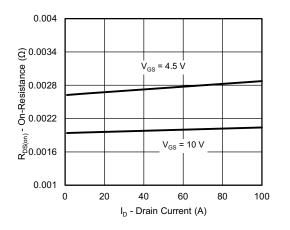
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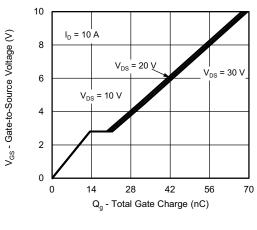
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



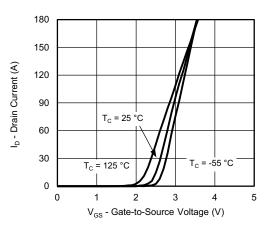
**Output Characteristics** 



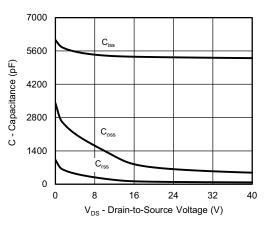
**On-Resistance vs. Drain Current** 



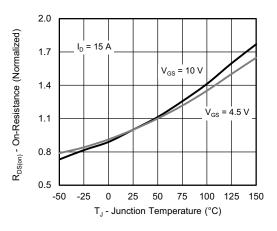
Gate Charge



**Transfer Characteristics** 



Capacitance



**On-Resistance vs. Junction Temperature** 

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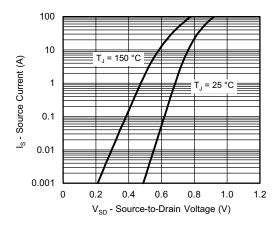
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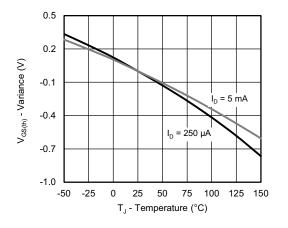
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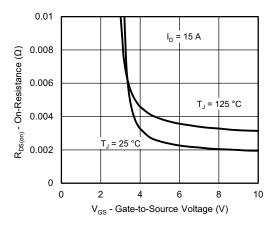
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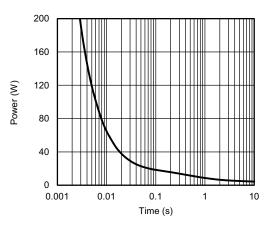
Source-Drain Diode Forward Voltage



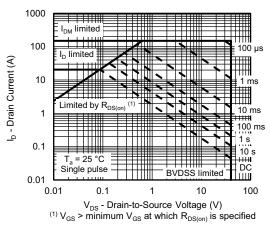
**Threshold Voltage** 



**On-Resistance vs. Gate-to-Source Voltage** 



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

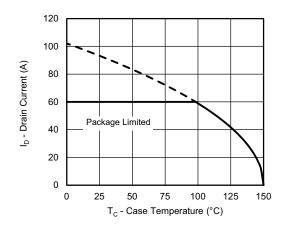
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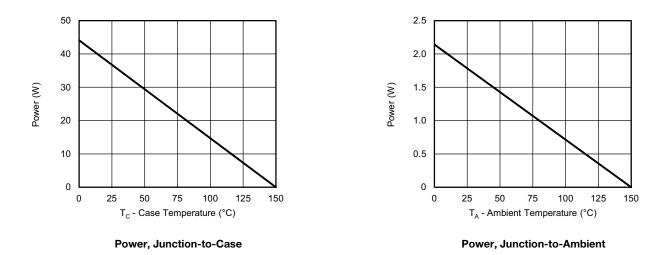
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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







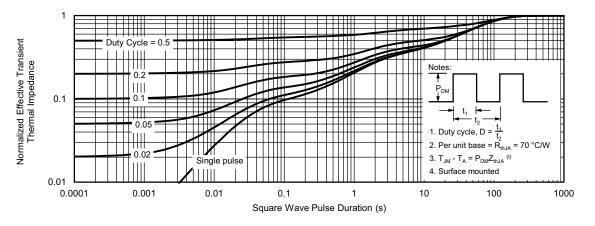
Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> (max.) = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

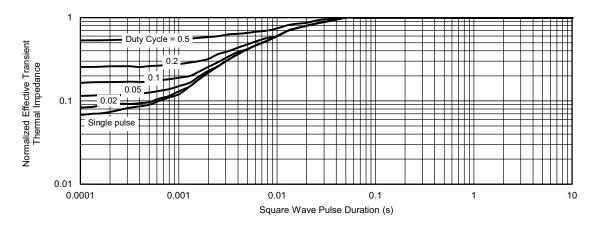
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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

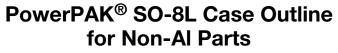


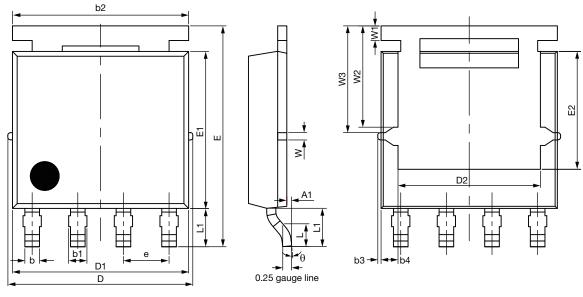
Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?67424.

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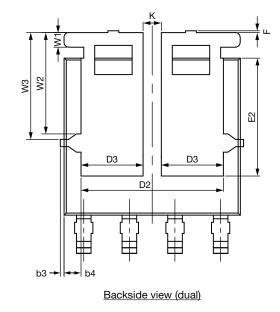


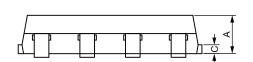




Topside view

Backside view (single)





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## **Package Information**



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514		MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
А	1.00	1.07	1.14	0.039	0.042	0.045		
A1	0.00	-	0.127	0.00	-	0.005		
b	0.33	0.41	0.48	0.013	0.016	0.019		
b1	0.44	0.51	0.58	0.017	0.020	0.023		
b2	4.80	4.90	5.00	0.189	0.193	0.197		
b3		0.094			0.004			
b4		0.47			0.019			
С	0.20	0.25	0.30	0.008	0.010	0.012		
D	5.00	5.13	5.25	0.197	0.202	0.207		
D1	4.80	4.90	5.00	0.189	0.193	0.197		
D2	3.86	3.96	4.06	0.152	0.156	0.160		
D3	1.63	1.73	1.83	0.064	0.068	0.072		
е		1.27 BSC		0.050 BSC				
E	6.05	6.15	6.25	0.238	0.242	0.246		
E1	4.27	4.37	4.47	0.168	0.172	0.176		
E2	3.18	3.28	3.38	0.125	0.129	0.133		
F	-	-	0.15	-	-	0.006		
L	0.62	0.72	0.82	0.024	0.028	0.032		
L1	0.92	1.07	1.22	0.036	0.042	0.048		
К		0.51			0.020			
W		0.23			0.009			
W1	0.41			0.016				
W2	2.82			0.111				
W3		2.96			0.117			
θ	0°	-	10°	0°	-	10°		

### Note

• Millimeters will gover



#### RECOMMENDED MINIMUM PAD FOR PowerPAK<sup>®</sup> SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)

Revision: 07-Feb-12



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